

Investor Relations



PSK GROUP

Apr. 2025

Disclaimer

All information regarding management performance and financial results of PSK Group (the "Company") during the end of 2024 as contained herein has been prepared in accordance with Korean International Financial Reporting Standards ("K-IFRS").

The information contained herein should not be utilized for any legal purposes in regard to investors' investment results. The Company hereby expressly disclaims any and all liability for any loss or damage resulting from the investors' reliance on the information contained herein.

Some of the information and data in this material have been prepared based on assumptions and forward-looking statements. Please note that such forward-looking assumptions and statements involve known and unknown risks, uncertainties and other factors and may be subject to change.

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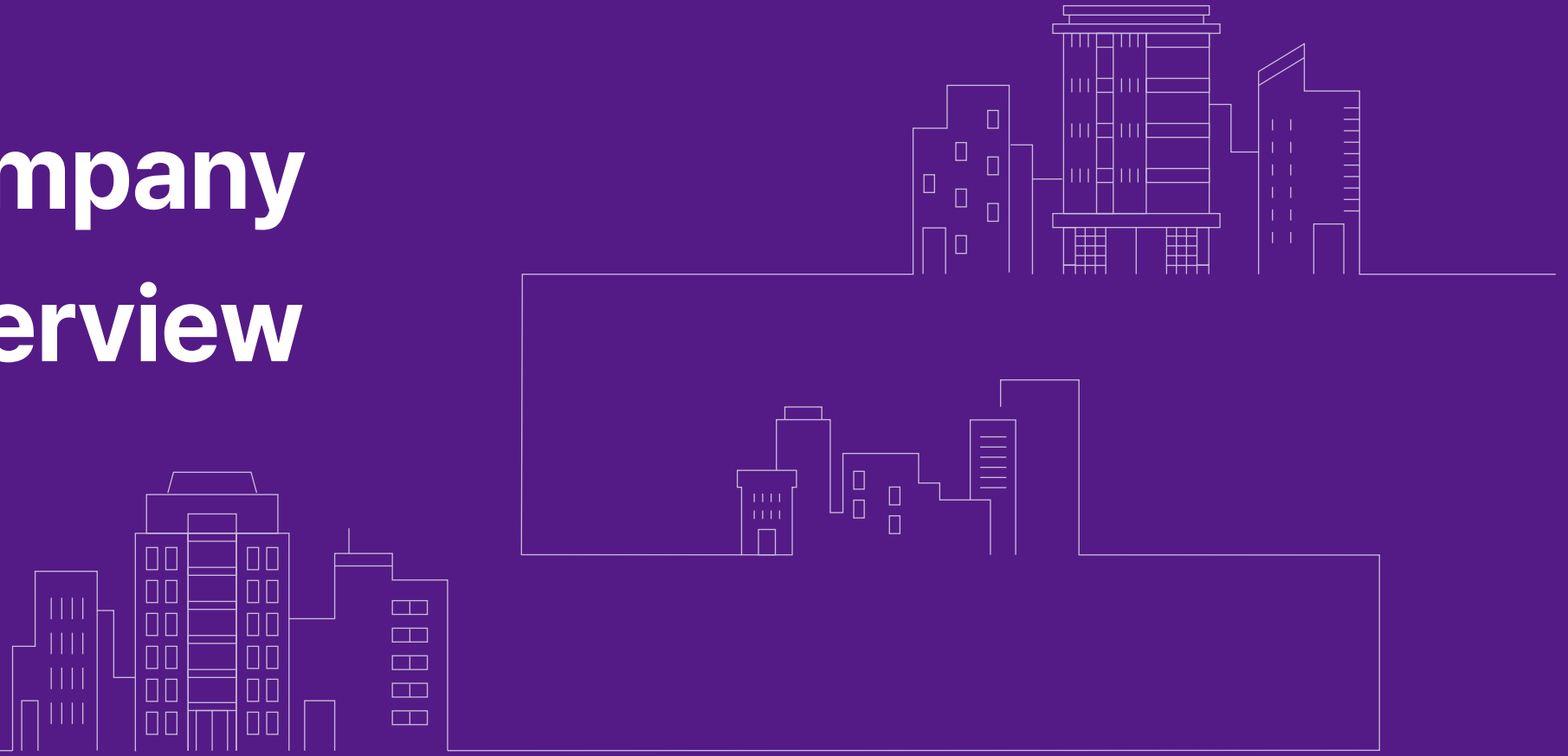
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Company Overview



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01



PSK Holdings

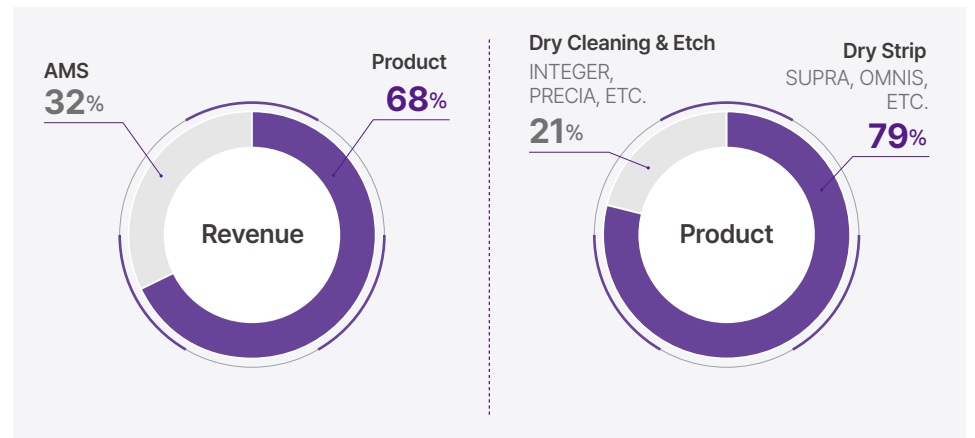
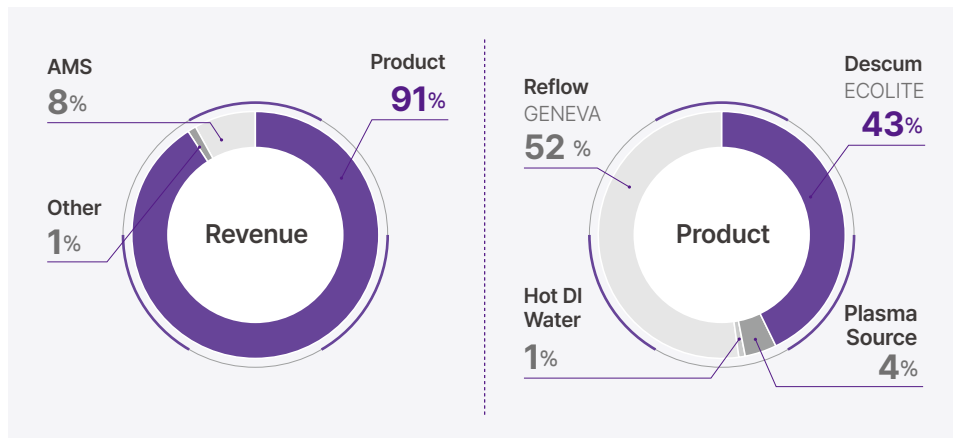
As of year-end 2024

Company Name	PSK Holdings Inc.
Incorporation	1990.06
Capital	10.78 billion
CEO	Kyoungsoo Park
Main Business	Semiconductor Equipment (292908)
Headcount	112 Employees
Address	48, Samsung 1ro 4-gil, Hwaseong-si, Gyeonggi-do, Korea, 18449
CEO Profile	PSK Group Chairman 1990 ~ Present PSK Holdings Inc. CEO 1990 ~ Present PSK Inc. Chairman 2019 ~ Present Chairman of KOSDAQ Listed Corporate Council 2007 ~ 2009

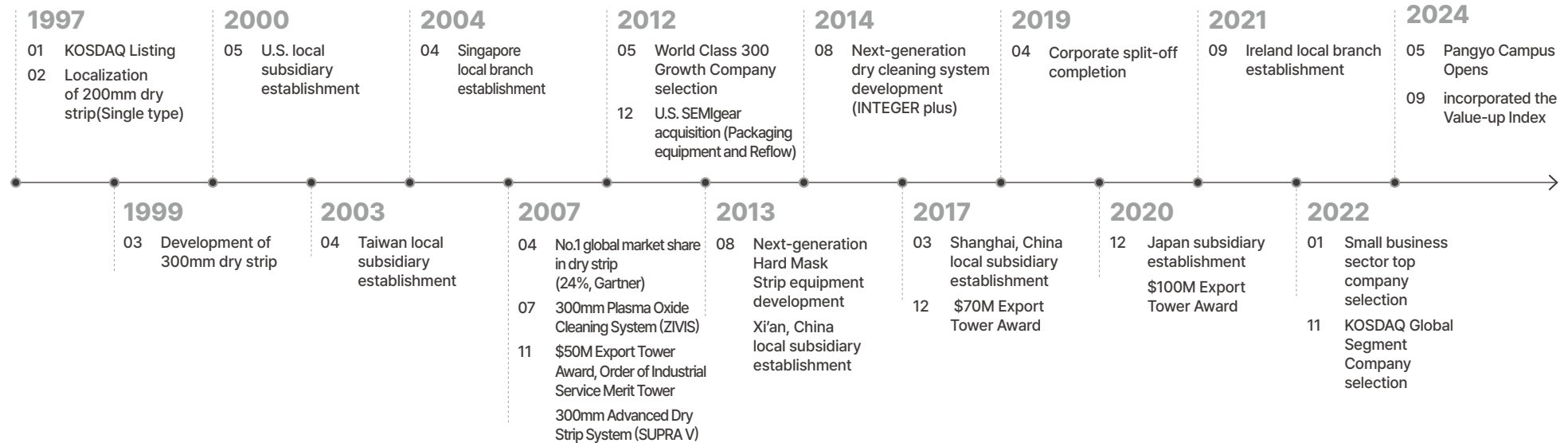
PSK

As of year-end 2024

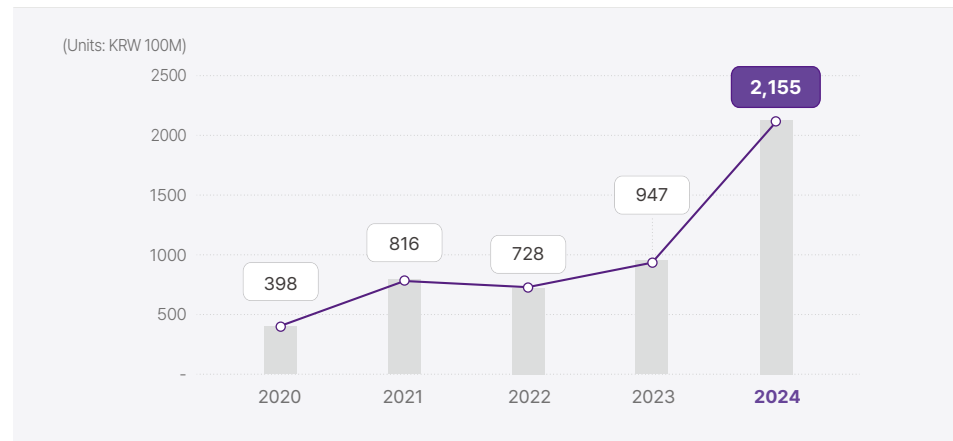
Company Name	PSK Inc.
Incorporation	2019.04
Capital	14.62 billion
CEO	Kevin Lee
Main Business	Semiconductor Equipment (292908)
Headcount	330 Employees
Address	48, Samsung 1ro 4-gil, Hwaseong-si, Gyeonggi-do, Korea, 18449
CEO Profile	PSK Inc. CEO 2019 ~ Present PSK Inc. 2016 ~ Present Mattson Technology 2004 ~ 2015 Applied Materials 1996 ~ 2003



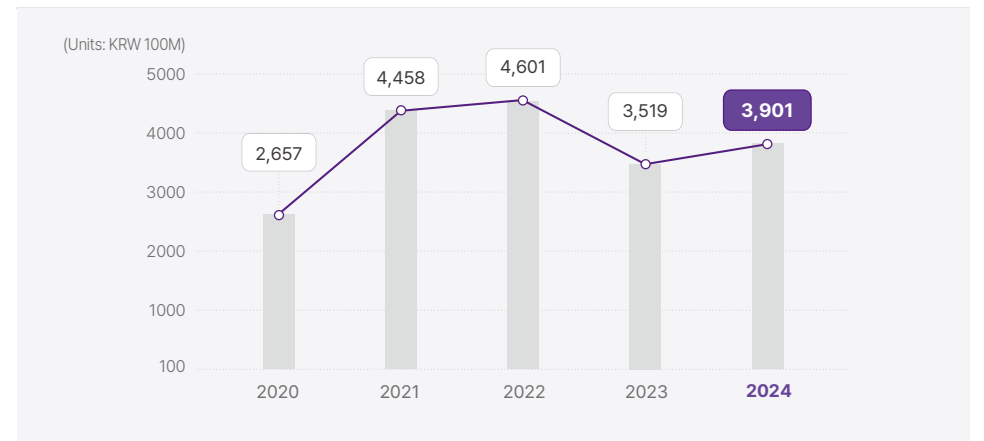
History



PSK Holdings Revenue (consolidated)



PSK Revenue (consolidated)





PSK Holdings

Location
Hwaseong, Republic of Korea

- 3D Package Equipment Business
 - Fluxless Reflow Equipment
 - Descum Equipment

▼ 32.76%

PSK

Location
Hwaseong, Republic of Korea

- Wafer Fab. Equipment Business
 - Dry Strip Equipment
 - Dry Cleaning Equipment
 - Plasma Wafer Edge Cleaning Equipment

➤ **SEMIgear** Technology Origin of Fluxless reflow

➤ **PSK Asia** Local sales & field service business

➤ **PSK China** Local sales & field service business

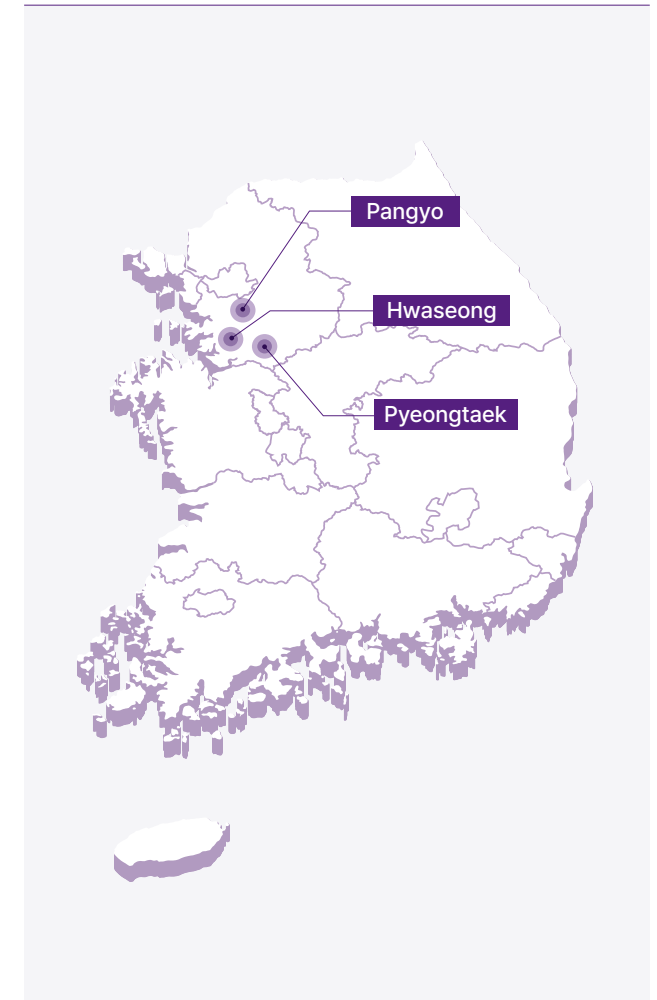
➤ **PSK Shanghai** Parts business

➤ **PSK America** Local sales & field service business

➤ **PSK Japan** Local sales & field service business

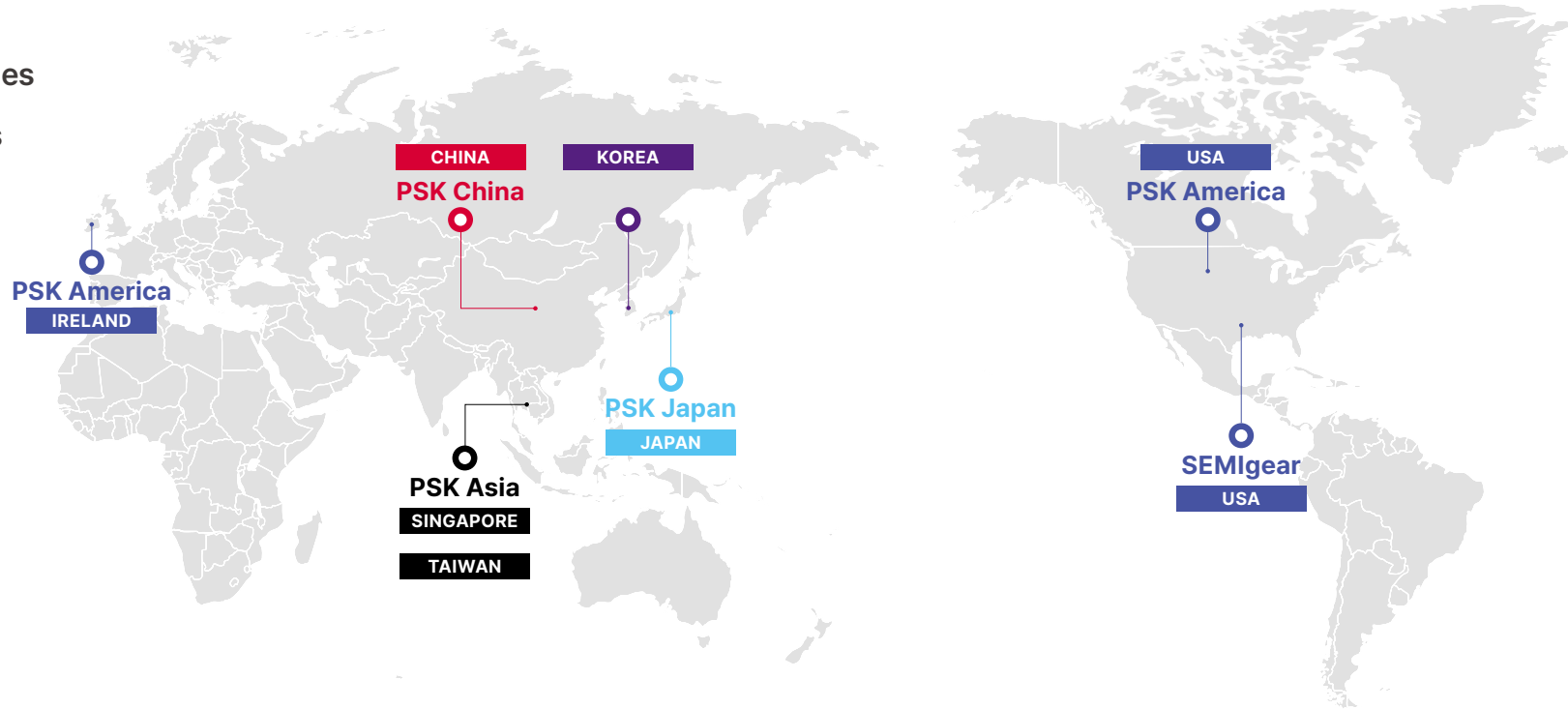
➤ **SE&S / SE&T / SE&I** Field service / parts assembly business

Republic of Korea





7 Countries
25 Sites



PSK (HQ)

- Hwaseong
- Pyeongtaek
- Pangyo

PSK Asia

- Hsinchu
- Linkou
- Taichung
- Tainan
- Singapore

PSK China

- Xian
- Hefei
- Chengdu
- Wuhan
- Xiamen
- Quanzhou
- Wuxi
- Dalian
- Shanghai
- Beijing

PSK Japan

- Hiroshima

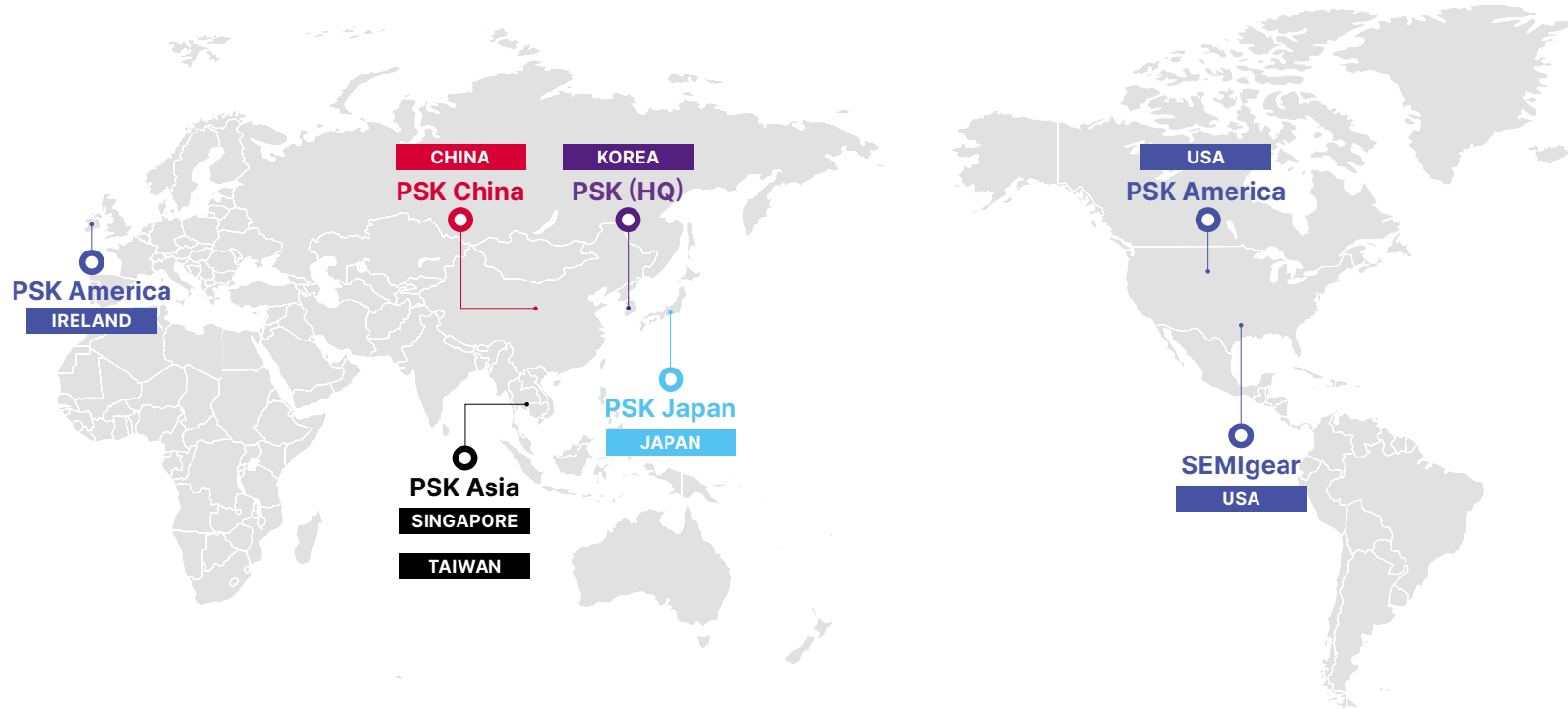
PSK America

- Hillsboro
- Boise
- Chandler
- Austin
- Dublin

SEMIgear

- Austin

Core Customers



Korea

SAMSUNG, SK hynix, ne:es

LB Semicon, DB HiTek, SFA SEMICON

Amkor technology, STATSchipPAC, Dow

China

YATC, SAMSUNG, JHIC 晋华, SK hynix, CHIPMORF

i!N INNOTRON, JSX, GLOBAL P&B DRORIES, jaup 江苏华电电子通信技术有限公司, GJCET

华天科技, 通宇微电, SJSEMI, CXMT, SMEC, EIT

Asia

UMC, winbond, CHIPROND, Winstek, Micron, hp

NANUK, MITI, Amkor Technology, GREATECH, GLOBAL P&B DRORIES, TATSchipPAC, ne:es

SPL, Powertech Technology Inc., tsmc, RAYTEK, Raytek Semiconductor, Inc., in FLASH SINGAPORE, sunsem, U-TAC

USA

Micron, SAMSUNG

intel, GLOBAL P&B DRORIES

IBM, qorvo

Europe

intel, GLOBAL P&B DRORIES

Japan

Micron, FE

FUJITSU, SONY, MITSUBISHI ELECTRIC, BOSOL

KIOXIA



Business Overview



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8 Major Processes

- Wafer
- Oxidation
- Photo Resist
- Etching [Asher]**
- Deposition
- Metallization
- EDS
- Packaging

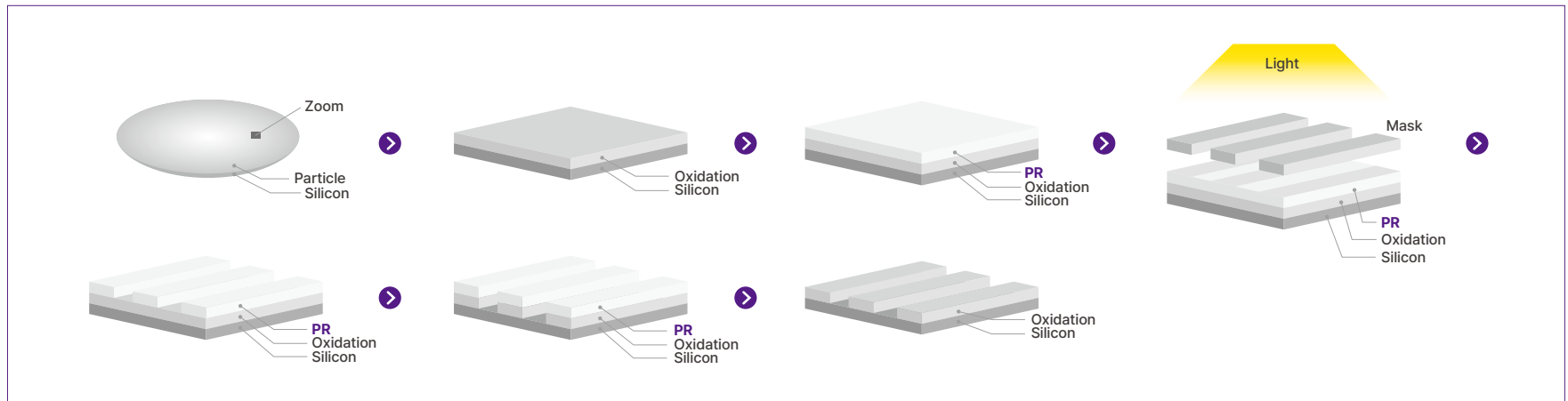
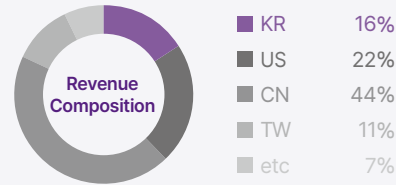
Global Leadership with World-Class Competitiveness

With the greatest market share worldwide, the SUPRA product line enables dry strip processing through its proven performance, and was designed with the smallest footprint to provide higher T/P and Lower CoO than conventional products.

In addition to bulk strip, we provide process solutions for various applications such as the improvement of HDIS process performance by using various types of chemistry, as well as metal layers and low-k materials.

Features

- High productivity
- High strip rate
- High reliability and low CoO





8 Major Processes

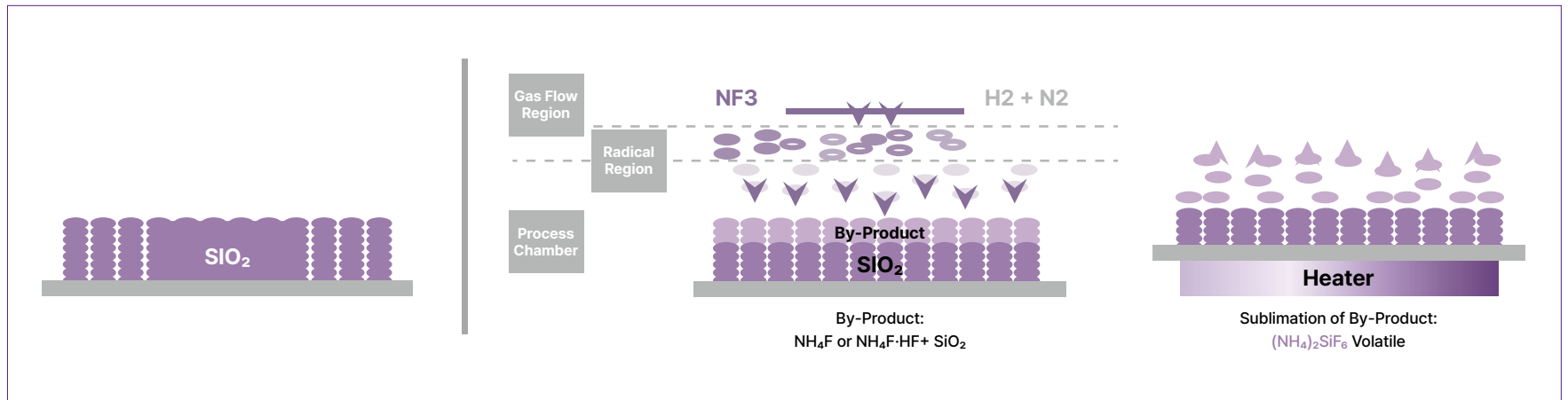
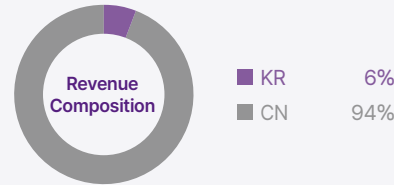
- Wafer
- Oxidation
- Photo Resist
- Etching [Asher]**
- Deposition
- Metallization
- EDS
- Packaging

World's No.1 Plasma Oxide Cleaning Process

This single-wafer process equipment enables high-aspect ratio contact cleaning and patterning in the semiconductor process by adjusting selectivity through a combination of chuck, baffle temperature, and various types of chemistry. It also provides isotropic etching and uniformity performance. This equipment has an advantage in throughput by transferring five wafers, and can realize high productivity with low CoO.

Features

- Plasma-enhanced cleaning system for removal of oxides, nitrides, and poly-Si
- Excellent cleaning capability for various AR contact patterns
- In-Situ damaged Si removal with high selectivity for SiN
- Excellent controllability for cleaning process





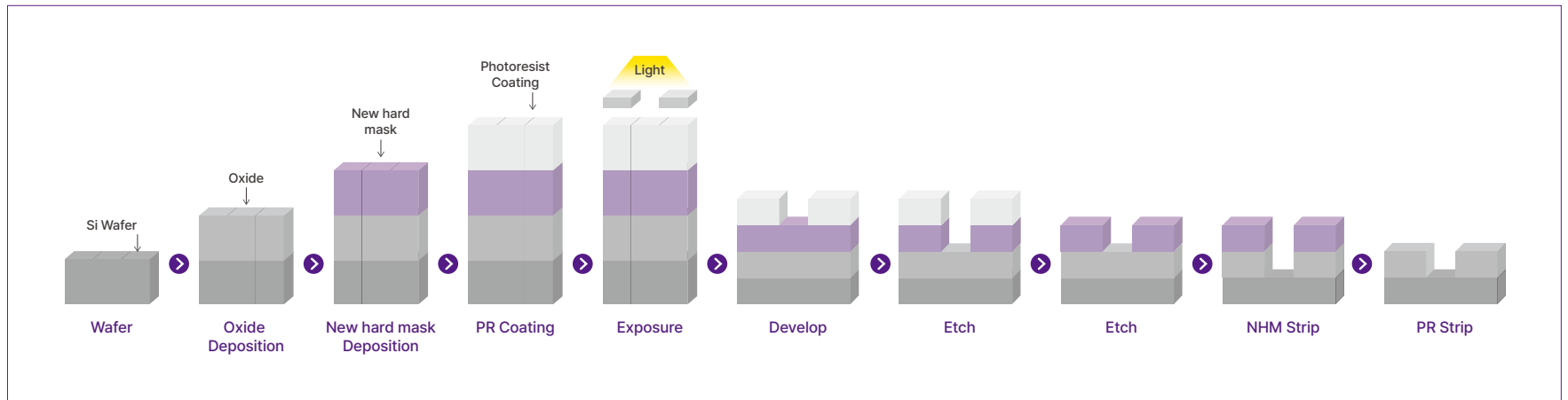
8 Major Processes
Wafer
Oxidation
Photo Resist
Etching [Asher]
Deposition
Metallization
EDS
Packaging

High Selectivity for Minimizing Damage Caused by Plasma

As a pattern size of device gets smaller, its aspect ratio is increasing. As a result, a film with high etching resistance, hard mask, is required during the etching process in the patterning. However high etching resistant film cannot be removed in a conventional removal process after etching. OMNIS offers a solution which selectively removes films by way of its high selectivity for films with high etching resistance as well as underlying films such as oxides and nitrides.

Features

- Unique product for doped hard mask removal
- Extreme selectivity for dielectric films
- Excellent hard mask strip performance without pattern damage
- Si oxidation controllability





8 Major Processes

- Wafer
- Oxidation
- Photo Resist
- Etching [Etcher]**
- Deposition
- Metallization
- EDS
- Packaging

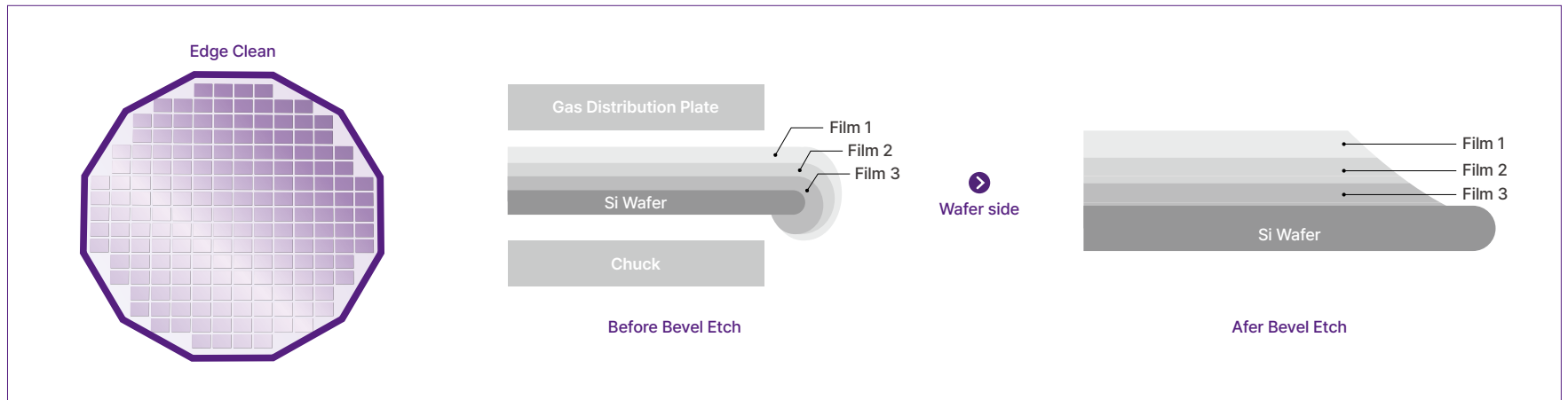
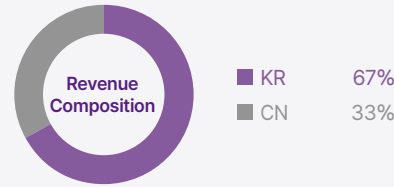
High Productivity, High Uniformity, and Low Equipment Maintenance Cost

PRECIA is wafer edge cleaning equipment for improving edge yield, providing advantages of low CoO and higher performance.

As plasma, ICP and CCP can be selectively used to exploit the advantages of each. In addition, an N2 Purge Load Port is included to control fumes that can occur after etching, and there are further advantages in dealing with particles thanks to the inclusion of a grip type that minimizes the contact area of wafers during a transfer.

Features

- High productivity & low CoO
- Dual plasma source
- High wafer transfer performance by precise auto wafer centering
- Wafer bevel etch monitoring with vision system





8 Major Processes

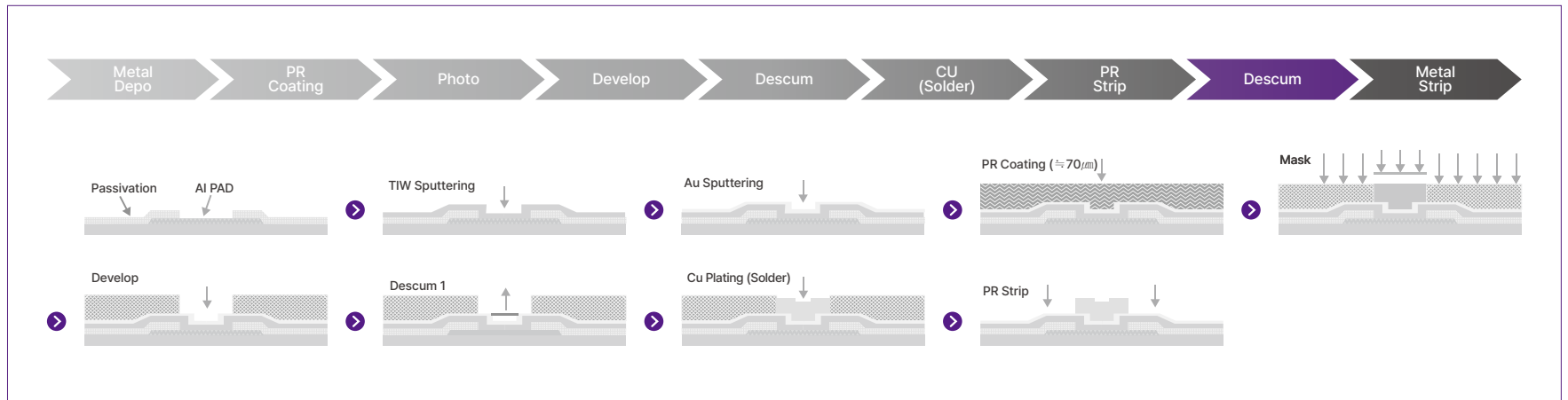
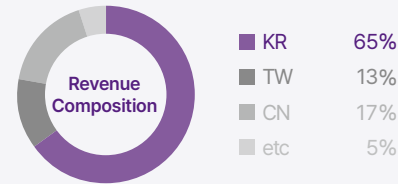
- Wafer
- Oxidation
- Photo Resist
- Etching
- Deposition
- Metallization
- EDS
- Packaging [Advanced Package]

World's Best Solution Provider in the Descum and Surface Treatment Field

Descum is a process to remove scum after lithography, and it is essential to guarantee good profile of RDL pattern and bump shape. Surface treatment is applied to remove residue or metallic ion at pre-film coating and post RDL etch. It allows adhesion improvement of coated film with changing surface roughness and hydrophilic property of base layer.

Features

- High productivity
- High reliability & low CoO
- Single & Dual plasma source
- Small footprint





8 Major Processes
Wafer
Oxidation
Photo Resist
Etching
Deposition
Metallization
EDS
Packaging [Advanced Package]

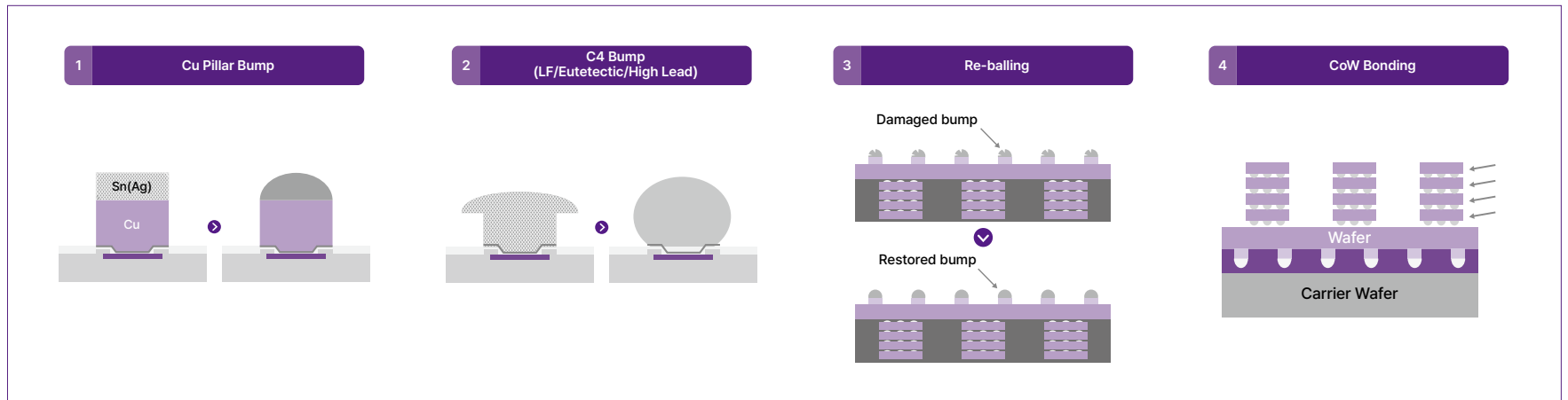
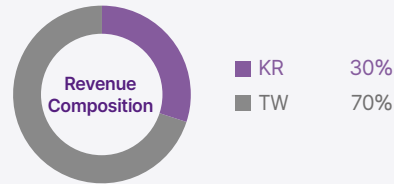
World-Class Competitiveness in the Fluxless Bump Reflow Field

Marketshare No.1 worldwide GENEVA is one of a kind with field proven stability and quality. It offers a solution to meet customer need such as warpage process, e.g. FOWLP, and high quality product.

In addition, GENEVA is in a process of development for mass production to apply at bonding reflow process as well as fluxless reflow process, e.g. CoW (chip on wafer) or SBM (solder ball mount).

Features

- Low CoO & high reliability
- Small footprint
- Warpage minimization
- High productivity
- High throughput & yield



Investment



Research Activities	19
New Product	20
CapEx	22



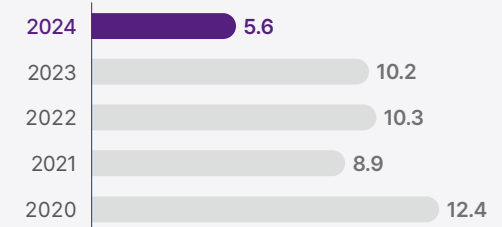
PSK Holdings

(Units: KRW M, %)

Year	2020	2021	2022	2023	2024
R&D Expenditure	4,918	7,296	7,514	9,682	12,080
Revenue	39,774	81,624	72,791	94,716	215,508
Employee	86	94	91	91	112
R&D Employee	33	34	33	34	41
Researcher Ratio	38.4	36.2	36.3	37.4	36.6

* Consolidated basis

R&D Expenditure as a percentage of revenue



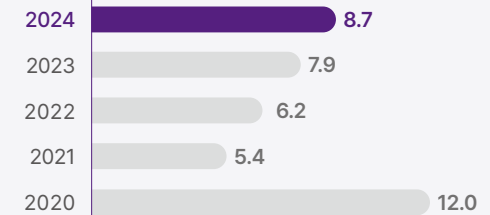
PSK

(Units: KRW M, %)

Year	2020	2021	2022	2023	2024
R&D Expenditure	31,936	24,153	28,755	27,720	34,439
Revenue	265,730	445,804	460,909	351,863	398,051
Employee	302	330	343	334	330
R&D Employee	109	120	122	122	127
Researcher Ratio	36.1	36.4	35.6	36.5	38.5

* Consolidated basis

R&D Expenditure as a percentage of revenue



New Product - PSK Holdings



(Units: KRW M, Case)

	R&D Exp	Patents (Cum.)	New Equip.
2020	4,918	309	Descum (II ver.)
2021	7,296	309	Reflow (STP200xp ver.)
2022	7,514	303	Reflow (xpd ver.)
2023	9,682	317	
2024	12,081	299	Descum (xp L ver.)

Patents (Cum.)



* Rights of the patents acquired prior to February 2019 are jointly owned by the spin-off entity and the surviving entity.



Descum (II ver.)



Reflow (xpd ver.)

New Product - PSK



(Units: KRW M, Case)

	R&D Exp	Patents (Cum.)	New Equip.
2020	31,936	312	
2021	24,153	330	Bevel Etch
2022	28,755	340	
2023	27,720	383	
2024	34,439	384	

Patents (Cum.)



* Rights of the patents acquired prior to February 2019 are jointly owned by the spin-off entity and the surviving entity.



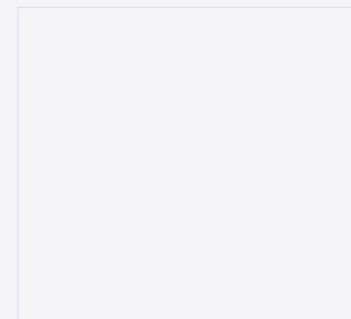
Dry Cleaning



NHM Strip



Bevel Etch



Metal Etch



Pangyo R&D Campus



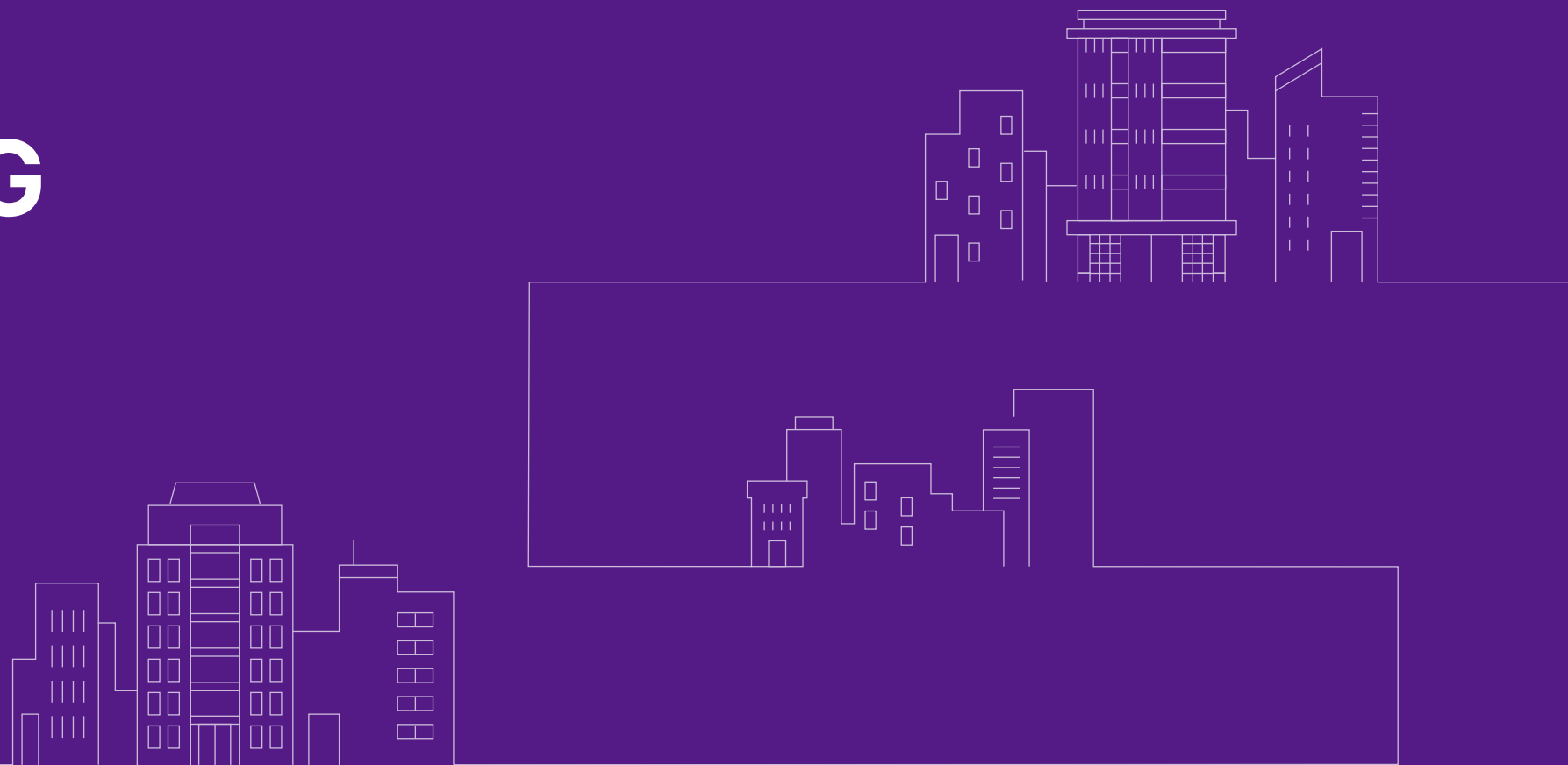
Location	Geumto-dong, Sujeong-gu, Seongnam-si, Gyeonggi-do (Pangyo 2nd Technovalley)
Scale	4,544 square meters of land 41,627 square meters of gross floor area
Investment Amount	₩82.5 B
Completion	May 2024

Yongin Semiconductor Cluster General Industrial Complex



Location	Wonsam-myeon, Chaerin-gu, Yongin-si, Gyeonggi-do (Next to the SK Hynix site)
Scale	15,412 square meters with a floor area ratio of 350% or less
Investment Amount	N/A
Completion	2028

ESG



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CEO Message

We strive to become a leading company in ESG Management that creates a sustainable future.

Dear Stakeholders,

We would like to express our sincere gratitude to our shareholders, customers, partners and employees for your unwavering interest and support for the PSK Group over the past 30 years.

Given the numerous challenges the business environment faces such as inflation, climate change, pollution, and infectious diseases, PSK Group strives to building a "sustainable future" for business continuity. In order to stay ahead of the curve, PSK Group holds sustainability as the highest management value and intends to apply it to each organization of the company.

PSK Group has established an environmental management systems through the ISO 14001 certification to create a sustainable management system and is boosting its eco-friendly activities such as efficient use of resources, energy savings, and green building construction. To fulfill our corporate social responsibilities, we are conducting various charitable activities such as donations and volunteer activities and are also making great efforts in the fields of human rights, safety and health. In addition, we are striving to advance our governance structure by introducing a board-centered management and an electronic voting system.

PSK Group will focus more on creating sustainable growth for the company by adding the value of ESG to its vision of "the global leader in total processing equipment".

Thank you.

PSK Holdings Inc.
CEO Kenneth Park



PSK Inc.
CEO Kevin Lee



ESG Committee



ISO Certification



Health and Safety

- 1. Health and Safety Goals → Establish annual safety and health goals and conduct bi-annual monitoring and compliance assessments
- 2. Hazardous Machinery Organization → Conduct self-inspection
- 3. Emergency Situations → Identify and assess potential emergencies and risks, establish response programs, business continuity plans (BCPs), regular drills, and ERT training
- 4. Employee Safety and Health → Operate regular training, periodic medical examinations, and health management programs

Serious Accident Management

- 1. Prevention → Identify high-risk tasks and hazards, install emergency warning lights and emergency contact networks at workplaces
- 2. Catastrophe Response Process Establishment → Build customized scenarios for each risk factor and conduct bi-annual response drills
- 3. Emergency Planning Committee → Bring forth emergency response committee and occupational safety and health committee in the event of a major disaster
- 4. Recurrence Prevention Plan Establishment
Establishing measures to prevent recurrence → Introduce implementation plan for measures to prevent recurrence, revise work processes
- 5. Monitoring and Training → Conduct continuous monitoring and safety education





Partnership Management

Every year, partnership management activities are conducted through the selection and awarding of outstanding Business Partner (BP) as part of PQCA (PSK Quality Certification Awards).

2024 PQCA

Date	February 3, 2025, PSK Pangyo Campus
Participants	PSK Group Key Partners
Purpose	Recognition of outstanding BP companies and sharing of agenda on 2024 purchase, quality, security, and strategies
Criteria for Outstanding BP Selection	In accordance with PSK SQP (Supplier Quality Platform), Key Partners are evaluated on the following three indicators : Quality, Delivery time, and Cooperation.



Social Contribution in 2024

PSK Group Volunteer Team 'Bongwoori' engages in various social contribution activities for the vulnerable groups in society, including the elderly, children, and the disabled.

January 17th
Coal briquette donation



May 18th
Environmental Cleanup Activity



September 9th
Chuseok (Korean Thanksgiving) donation



October 23th
Neighborhood Charity Bazaar



November 3rd
Beautiful Companion Marathon



November 23th
Kimchi sharing



BOD Structure and Independence



PSK Holdings

Board of Directors	Kyoung Soo Park Chairman/CEO <ul style="list-style-type: none"> • BBA, Korea University • MBA, University of California, Los Angeles • PSK Inc. Chairman of the Board of Directors 	Jae Gyun Yang Internal Director <ul style="list-style-type: none"> • B.S., Metallurgical Engineering, Seoul National University • M.S., Materials Science and Engineering, KAIST • Daewoo Semiconductor 	Jin Kyung Park Internal Director <ul style="list-style-type: none"> • BS, Industrial Design, KAIST • NHN • XLGMES 	Sa Yoon Kang External Director <ul style="list-style-type: none"> • Team Leader of PKG Development Team at Samsung Electronics Co., Ltd • Team Leader, PLP Business Team, Samsung Electro-Mechanics Co., Ltd • President, Korea Society of Microelectronics and Packaging 	Jin Wook Jung External Director <ul style="list-style-type: none"> • Ph.D., Physics, KAIST • Professor, Hanyang Univ. • Semiconductor Display Technology Society Plasma President of RF Research
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PSK

Board of Directors	Kyoung Soo Park Chairman/CEO <ul style="list-style-type: none"> • BBA, Korea University • MBA, University of California, Los Angeles • PSK Holdings Inc. Chairman of the Board of Directors 	Kevin Lee CEO <ul style="list-style-type: none"> • M.S., Materials Engineering, KAIST • Ph.D., Materials Engineering, Seoul National University • Applied Materials 	Dong Jin Kim Internal Director <ul style="list-style-type: none"> • Columbia Business School MBA • Samsung Electronics Co., Ltd • Hewlett-Packard 	Pil Sung Kang External Director <ul style="list-style-type: none"> • Ph.D., Industrial Engineering, Seoul National University • Professor, Seoul National Univ. • Professor, LG CNS Manufacturing AI 	Woo In Jung External Director <ul style="list-style-type: none"> • Ph.D., Materials Engineering, KAIST • Professor, Yonsei Univ. • Lam Resarch Korea
	Management	Hyung Chan Ha <ul style="list-style-type: none"> • Ph.D., Materials Science and Engineering, Leight University • SK Hynix Inc. • Applied Materials 	Kee Bo Choi <ul style="list-style-type: none"> • M.S., Phsyics, Yonsei University • Samsung Electronics Co., Ltd • Applied Materials 	Yeon Kyung Park <ul style="list-style-type: none"> • M.S., Business Administration, Seoul National University • Samsung Electronics Co., Ltd • Lotte HomeShopping 	



Samsung Electronics Co., Ltd

2021 삼성전자 협력사 ESG 평가

I. 평가 결과 요약

종합점수 95.8 점

회사명	피에스케이이머
매출액	265,729,684,455 원
임직원현황(2020.12.31 기준)	전체 : 302명 정규직 : 298명 비정규직 : 4명
위치	본사주소: 경기도 화성시 삼성1로 4길 48 현장명문 사업장 주소: 경기도 화성시 삼성1로 4길 48

II. 평가 결과

영역	영역별 점수
E. 환경	94.1 점
S. 사회	97.6 점
G. 지배구조	95.6 점
종합점수	95.8 점

평가결과 비교 점수

기업	구분	평가점수	전체 기업 평균점수	전체 기업 최저점수	전체 기업 최고점수
피에스케이이머	E. 환경	94.1	79.4	27.3	100
	S. 사회	97.6	84.4	36.2	100
	G. 지배구조	95.6	80	38.3	98.3
	종합점수	95.8	81.3	33.9	99.4

2021 Online Supplier Assessment results show that PSK Inc. outperformed the average of all Suppliers in each ESG area by achieving an outstanding overall score of 99.4/100.

SK Hynix Inc.

1. ESG 현장평가 결과

I. 기업 정보

회사명	피에스케이 주식회사	대기배출 사실	대응없음
주요사업	반도체 장비(한 공장 장비)	폐수처리 사실	대응없음
법인사업장	경기도 화성시 삼성1로 4길 48(사우동)	위험물 보관 및 사용 사실	대응없음
평가 일자	2023년 4월 24일	지정폐기물 관련 대상 여부	대응없음
인원 수	339명	중성가스 배출관리대상	대응없음
외국인	있음	사내도입업체	보유

II. ESG 현장평가 결과 요약

구분	평균	최고	최저	표준편차
종합	84.1	77.6	97.9	53.7
노동 및 인권	81.1	72.9	90.8	51.1
안전 및 보건	86.0	91.0	98.4	74.6
환경	78.6	80.1	100.0	33.3
윤리	54.7	53.5	87.6	9.1
경영시스템	9.0	3.2	9.0	0.3

III. 기업별 점수 분포

IV. 전문가 종합 의견

- ▶ 검토되는 개선 사항 노동 및 인권, 안전 및 보건, 환경, 윤리 및 경영시스템의 ESG 요건을 적용할 관련 통제하고 있는지 평가하였습니다. 평가 과정에서 귀사로부터 대량 사용의 자료 등 서면근거를 확인하였으며, 이러한 근거가 실체적 사실로 부합하지는 확인하기 위하여 2023년 4월 24일에 현장평가를 실시하였습니다.
- ▶ SK하이닉스 2023 협력사 ESG 현장평가 결과로 귀사의 현재의 ESG 관리수준은 84.1점으로 평가되었습니다. 노동 및 인권, 안전 및 보건, 환경, 경영시스템 분야는 ESG 위주의 기업 요건을 적용할 수준에서 관리 중이며, 윤리 및 지배구조는 ESG 평가에서 요구되는 사항에 충족시킬 수 있으며, 윤리 분야의 관리체계는 다소 미흡한 상태를 나타내며 ESG 평가에서 요구하는 사항을 충족시키기 위해 세부 이행사항에 대한 개선할 필요가 있습니다.
- ▶ 검토되는 이상의 사항을 종합하여 귀사가 필요한 수준에서 적절한 ESG 요건을 관리 및 통제하고 있음에 따라 비재무적 요인으로 인한 이해관계자 가치 향상에 기여하고 있다고 결론 내리는 바입니다.
- ※ 영역별 세부 이용목적 및 권고내용은 후속되는 페이지를 참고하시기 바랍니다.

After completing an online self-assessment in 2021, the customer visited the headquarters in April 2023 to conduct an on-site due diligence. Achieved an overall score of 84.1, which is above the average for all suppliers specifically represent the top 45% quartile.

Intel

Responsible Business Alliance

Advancing Sustainability Globally

Recognition that

PSK Inc

48, Samsung 1ro 4-gil, Hwaseong-si, Gyeonggi-do, 18449 South Korea

Completed the RBA Validated Assessment Program, achieving **SILVER** Status without any priority findings, earning a score of 193.4

Validated Audit Report: VAR-20230710-KR-01B02-1
 Audit date: July 10, 2023
 Certificate issue date: July 29, 2023
 Expiration date: October 7, 2024

Robert F. Lederer
CEO, RBA

Intel 2022 EPIC Supplier 선정

Excellence, Partnership, Inclusion, Continuous Improvement 의 약자로, Outstanding, Distinguished, Valued Supplier 등 3개 부문 의 수상을 진행. PSK는 Quality, Technology Development, Service 부문에서 우수한 퍼포먼스를 보여 Valued Quality Award 수상

Intel Announces 2022 EPIC Supplier Program Award Recipients

Since the onset of the initial assessment in November 2022, PSK Holdings achieved 193.4 points out of 200 after addressing previously identified issues over the course of a year

Performance



Financial Information	31
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Performance of 2024 Q4

(Billion KRW)

	24Y 4Q	24Y 3Q	QoQ	24Y 4Q	YoY
Sales Revenue	97.8	39.1	60.0%	39.4	148.2%
Gross Margin	65.9	22.5	65.9%	2.5	160.5%
SG&A	22.8	8.2	64.0%	11.3	101.8%
Operating Income	43.2	14.3	66.9%	14.1	206.4%

*Consolidated Financial Statements

Summary of Financial Statements

B/S (Unit: Billion, Currency: ₩)

	2022		2023		2024	
Assets	328.4	100.0%	401.4	100.0%	543.6	100.0%
Current Assets	128.4	39.1%	165.2	41.2%	214.1	46.9%
Liabilities	46.3	14.1%	60.1	15.0%	82.1	16.0%
Current Liabilities	22.2	47.9%	35.1	58.4%	51.7	63.0%
Equity	282.2	85.9%	341.3	85.0%	431.5	84.0%
Issued Capital	10.8	3.8%	10.8	3.2%	10.8	2.5%
Ratio of debt to equity	16.4%		17.6%		19.0%	

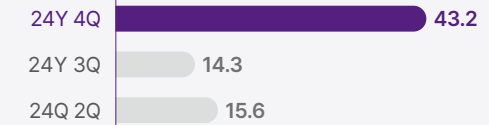
*Consolidated Financial Statements

I/S (Unit: Billion, Currency: ₩)

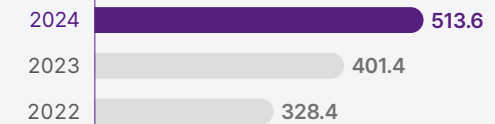
	2022	2023	2024
Revenue	72.8	94.7	215.5
Gross Profit	42.5	57.9	135.8
Operating Income	16.9	27.0	88.5
Net Income	40.8	42.7	95.8
Ratio of operating income to revenue	23.2	28.5	41.1

*Consolidated Financial Statements

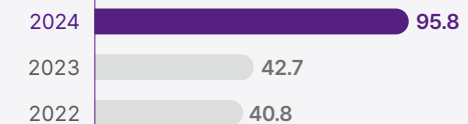
Operating Income



Assets



Net Income





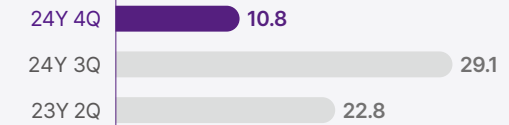
Performance of 2024 Q4

(Billion KRW)

	24Y 4Q	24Y 3Q	QoQ	24Y 4Q	YoY
Sales Revenue	105.3	118.0	-12.1%	108.7	-3.1%
Gross Margin	53.1	60.8	-14.5%	52.1	1.9%
SG&A	42.6	31.6	25.8%	36.2	17.7%
Operating Income	10.8	29.1	-169.4%	15.9	-32.1%

*Consolidated Financial Statements

Operating Income



Summary of Financial Statements

B/S

(Unit: Billion, Currency: ₩)

	2022		2023		2024	
Assets	472.2	100.0%	494.4	100.0%	569.4	100.0%
Current Assets	384.0	81.3%	353.6	71.5%	398.6	70.0%
Liabilities	119.3	25.3%	101.8	20.6%	97.6	17.1%
Current Liabilities	100.9	84.6%	68.1	84.6%	81.2	83.2%
Equity	353.3	74.8%	392.5	79.4%	471.7	82.8%
Issued Capital	14.6	4.1%	14.6	3.7%	14.6	3.1%
Ratio of debt to equity	33.8%		25.9%		20.7%	

*Consolidated Financial Statements

Assets



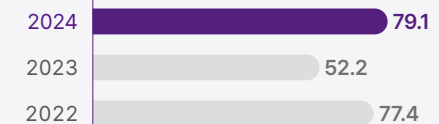
I/S

(Unit: Billion, Currency: ₩)

	2022	2023	2024
Revenue	460.9	351.9	398.1
Gross Profit	213.4	164.6	209.6
Operating Income	91.8	54.1	84.0
Net Income	77.4	52.5	79.1
Ratio of operating income to revenue	19.9	15.4	21.1

*Consolidated Financial Statements

Net Income





PSK Holdings

(Currency: ₩, 1 Share)

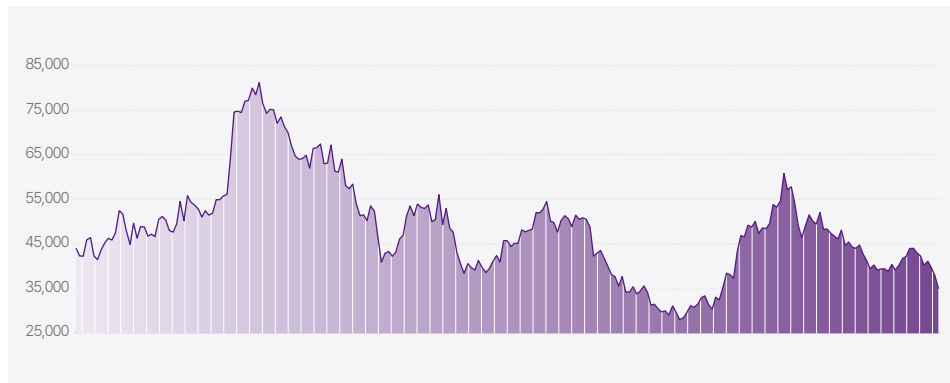
	2022	2023	2024
DSP	500	600	700

*Consolidated Financial Statements

	2022	2023	2024
Dividend Payout Ratio	25.0%	30.3%	15.8%

*Consolidated Financial Statements

	2022	2023	2024
EPS (₩)	1,890	1,980	4,444
BPS (₩)	13,597	15,829	20,010
PER (x)	3.6	13.6	8.6
PBR (x)	0.5	1.7	1.9
ROE (%)	15.3	13.7	24.8
ROA (%)	12.9	11.7	20.9
ROIC	17.2	28.9	61.0



PSK

(Currency: ₩, 1 Share)

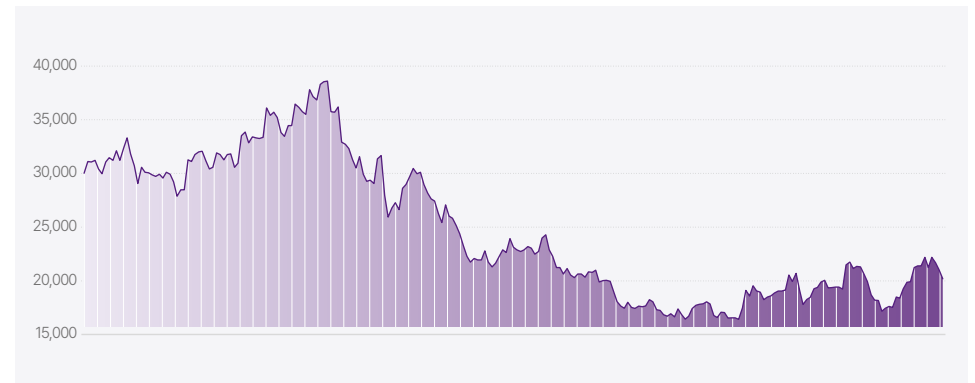
	2022	2023	2024
DSP	400	200	400

*Consolidated Financial Statements

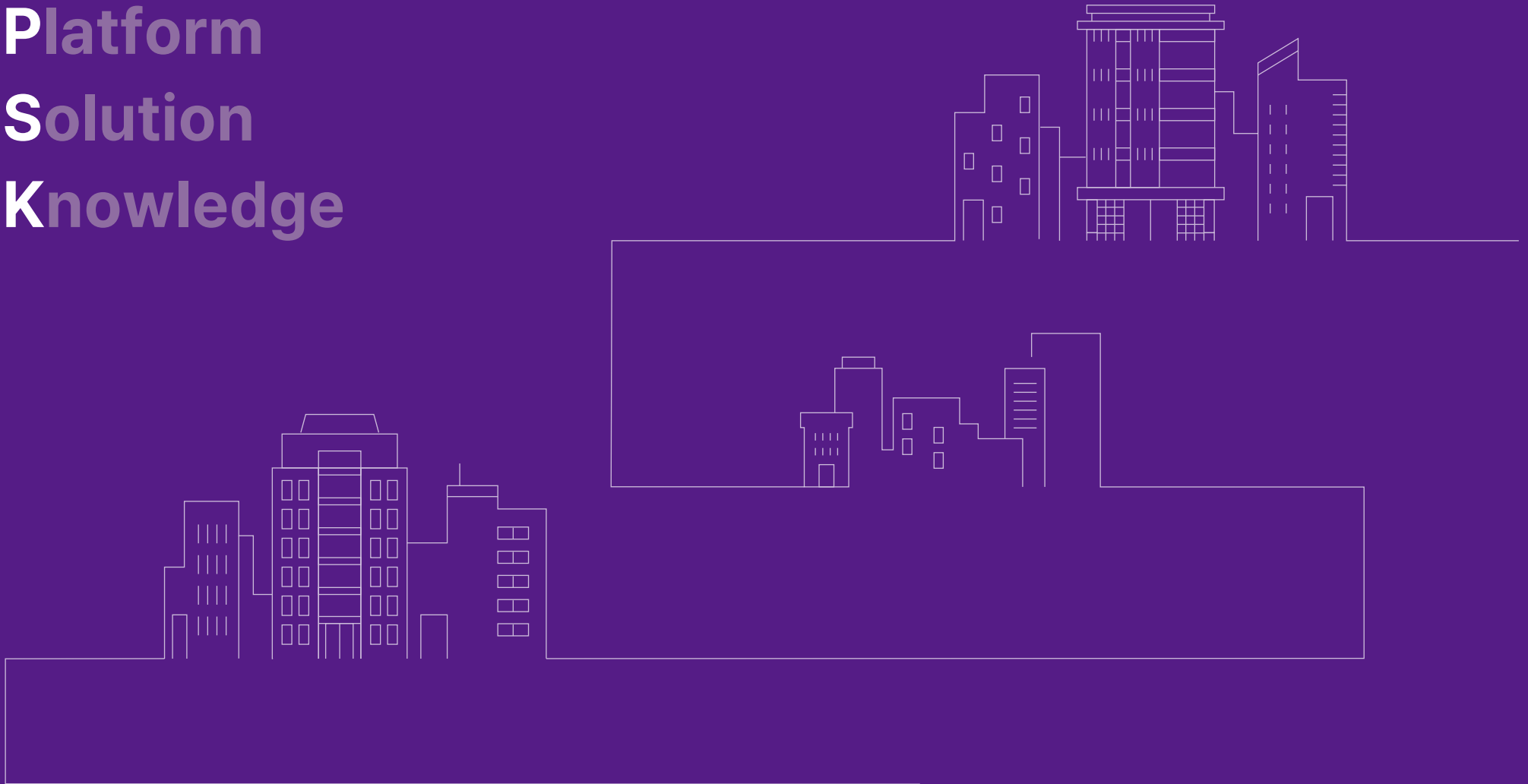
	2022	2023	2024
Dividend Payout Ratio	15.0%	11.0%	14.6%

*Consolidated Financial Statements

	2022	2023	2024
EPS (₩)	2,647	1,813	2,732
BPS (₩)	12,197	13,552	16,285
PER (x)	5.8	11.6	6.0
PBR (x)	1.3	1.6	1.0
ROE (%)	24.1	14.1	18.3
ROA (%)	17.5	10.9	14.9
ROIC	35.8	20.0	28.5



Platform Solution Knowledge



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